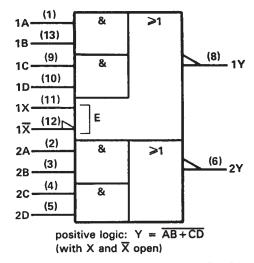
- Package Options Include Plastic and Ceramic DIPs and Ceramic Flat Packages
- Dependable Texas Instruments Quality and Reliability

description

These devices contain two independent 2-wide 2-input AND-OR-INVERT gates with one gate expandable. They perform the Boolean function $Y = \overline{AB + CD}$ with X and \overline{X} left open.

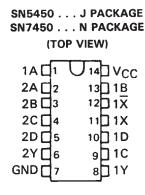
The SN5450 is characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7450 is characterized for operation from 0 °C to 70 °C.

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

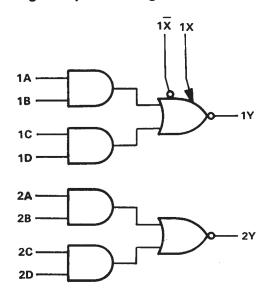
Pin numbers shown are for J and N packages.



SN5450 . . . W PACKAGE (TOP VIEW)

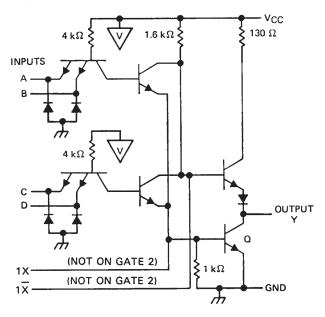
14 1D
13] 1C
12 1Y
11 GND
10 2Y
9 2D
8 2C

logic diagram (positive logic)





schematic (each AND-OR-INVERT gate)



Resistor values shown are nominal. If expander is not used, leave X and \overline{X} open.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		/ V
Input voltage		5.5 V
Operating free-air temperature range:	SN5450	-55°C to 125°C
Operating free an temperature range.	SN7450	0°C to 70°C

NOTE 1: Voltage values are with respect to network ground terminal.



recommended operating conditions

•			SN5450			SN7450			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧	
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.8			8.0	V	
ЮН	High-level output current			- 0.4			- 0.4	mA	
loL	Low-level output current			16			16	mA	
TA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			SN5450				UNIT			
	TEST CONDITIONS†			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I ₁ = - 12 mA				1.5			- 1.5	٧
Voн	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 0.4 mA	2.4	3.4		2.4	3.4		٧
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	V
11	V _{CC} = MAX,	V _i = 5.5 V				1			1	mA
ин	V _{CC} = MAX,	V _{IH} = 2.4 V				40			40	μΑ
ΠL	V _{CC} = MAX,	V _{IL} = 0.4 V				- 1.6			– 1.6	mΑ
loss	V _{CC} = MAX			- 20		- 55	- 18		– 55	mA
ГССН	V _{CC} = MAX,	V ₁ = 0 V			4	8		4	8	mA
ICCL	V _{CC} = MAX,	See Note 2			7.4	14		7.4	14	mA
ı⊼·¶	$V\overline{\chi}\chi = 0.4 V$	I _{OL} = 16 mA				- 2.9			- 3.1	mA
	$I_X + I_{\overline{X}} = 0.41 \text{ mA},$	$R\overline{\chi}\chi = 0$,	I _{OL} = 16 mA			1.1				V
V _{BE(Q)} ¶ 1×	$1_X + 1_{\overline{X}} = 0.62 \text{ mA},$	$R\overline{\chi}\chi = 0$,	I _{OL} = 16 mA						1	
., •	I _X = 0.15 mA,	$I\overline{\chi} = -0.15 \mathrm{mA}$	I _{OH} = - 0.4 mA	2.4	3.4					V
∨ _{OH} ¶	I _X = 0.27 mA,	$I\overline{\chi} = -0.27 \text{ mA},$	I _{OH} = - 0.4 mA				2.4	3.4		<u> </u>
· · ·	$I_X + I_{\overline{X}} = 0.3 \text{ mA},$	$R\overline{\chi}X = 138 \Omega$,	I _{OL} = 16 mA		0.2	0.4				V
v _{ol} ¶	$I_X + I_{\overline{X}} = 0.43 \text{ mA},$	$R\overline{\chi}_X = 130 \Omega$,	I _{OL} = 16 mA					0.2	0.4	,

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		TYP	MAX	UNIT
tPLH		V	$R_L = 400 \Omega$, $C_L = 15 pF$		13	22	ns
tPHL	Any	Υ	Expander pins open		8	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time.

 $[\]P$ Using expander inputs, $V_{CC} = MIN$, $T_A = MIN$, except typical values. NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

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